



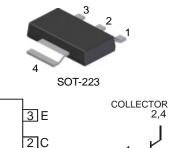


#### **Features**

- **Epitaxial Planar Die Construction**
- Complementary PNP Type Available (DZT2907A)
- Ideally Suited for Automated Assembly Processes
- Ideal for Medium Power Switching or Amplification Applications
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)

#### **Mechanical Data**

- Case: SOT-223
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Matte Tin annealed over Copper Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 4
- Ordering Information: See Page 4
- Weight: 0.115 grams (approximate)





1 B

## **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	75	V
Collector-Emitter Voltage	V <sub>CEO</sub>	40	V
Emitter-Base Voltage	V <sub>EBO</sub>	6	V
Collector Continuous Current	Ic	600	mA

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation @ T <sub>A</sub> = 25°C (Note 3)	$P_d$	1	W
Thermal Resistance, Junction to Ambient Air (Note 3) @T <sub>A</sub> = 25°C	$R_{ hetaJA}$	125	°C/W
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>STG</sub>	-55 to +150	°C

Notes:

- No purposefully added lead.
- Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead\_free/index.php.

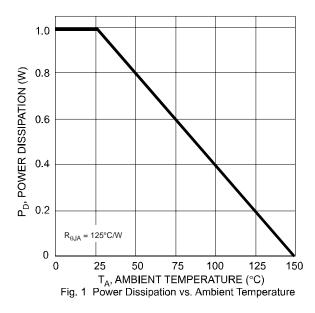
  Device mounted on FR-4 PCB pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

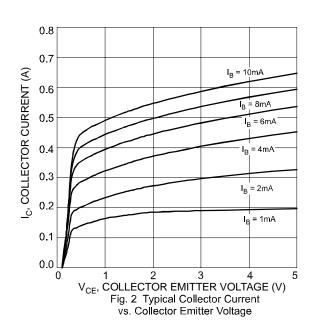


# **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Conditions	
OFF CHARACTERISTICS (Note 4)						
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	75	_	V	$I_C = 10\mu A, I_E = 0$	
Collector-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	40	_	V	$I_C = 10 \text{mA}, I_B = 0$	
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	6		V	$I_E = 10\mu A, I_C = 0$	
Collector Cut-Off Current	I <sub>CBO</sub>	_	10	nA	$V_{CB} = 50V, I_E = 0$	
Conector Gut-On Guttern			10	μΑ	$V_{CB} = 50V$ , $I_E = 0$ , $T_A = 150$ °C	
Emitter Cut-Off Current	I <sub>EBO</sub>		10	nΑ	$V_{EB} = 3V, I_{C} = 0$	
Collector-Emitter Cut-Off Current	I <sub>CEX</sub>	_	10	nA	$V_{CE} = 60V$ , $V_{EB(off)} = 3V$	
ON CHARACTERISTICS (Note 4)				_		
Collector-Emitter Saturation Voltage	V <sub>CE(SAT)</sub>	_	0.3	V	$I_C = 150 \text{mA}, I_B = 15 \text{mA}$	
Collector-Emitter Saturation Voltage	V CE(SAT)	_	1.0	V	$I_C = 500 \text{mA}, I_B = 50 \text{mA}$	
Base-Emitter Saturation Voltage	VDE (0.4T)	0.6	1.2	V	$I_C = 150 \text{mA}, I_B = 15 \text{mA}$	
Dase-Emitter Saturation voltage	V <sub>BE(SAT)</sub>		2.0	V	$I_C = 500 \text{mA}, I_B = 50 \text{mA}$	
		35			$I_C = 0.1 \text{mA}, V_{CE} = 10 \text{V}$	
	hFE	50	_		$I_C = 1 \text{mA}, V_{CE} = 10 \text{V}$	
		75			$I_C = 10 \text{mA}, V_{CE} = 10 \text{V}$	
DC Current Gain		35			$I_C = 10 \text{mA}, V_{CE} = 10 \text{V}, T_A = -55 ^{\circ}\text{C}$	
		100	300		$I_C = 150 \text{mA}, V_{CE} = 10 \text{V}$	
		50	_		$I_C = 150 \text{mA}, V_{CE} = 1 \text{V}$	
		40	_		$I_C = 500 \text{mA}, V_{CE} = 10 \text{V}$	
SMALL SIGNAL CHARACTERISTICS				_		
Transition Frequency	f⊤	300	_	MHz	$I_C = 20 \text{mA}, V_{CE} = 20 \text{V}, f = 100 \text{MHz}$	
Output Capacitance	C <sub>obo</sub>		8	pF	$V_{CB} = 10V, I_E = 0, f = 1MHz$	
Input Capacitance	$C_{ibo}$	_	25	pF	$V_{EB} = 0.5V, I_{C} = 0, f = 1MHz$	
SWITCHING CHARACTERISTICS						
Delay Time	t <sub>d</sub>		10	ns	$V_{CE} = 30V$ , $V_{EB(off)} = 0.5V$ , $I_{C} = 150$ mA, $I_{B1} = 15$ mA	
Rise Time	t <sub>r</sub>		25	ns		
Storage Time	ts	_	225	ns	$V_{CE} = 30V$ , $I_C = 150mA$ , $I_{B1} = I_{B2} = 15mA$	
Fall Time	t <sub>f</sub>	_	60	ns		

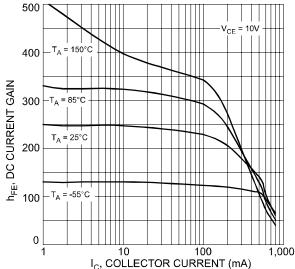
Notes: 4. Measured under pulsed conditions. Pulse width = 300  $\mu$ S. Duty Cycle, d< = 2%.



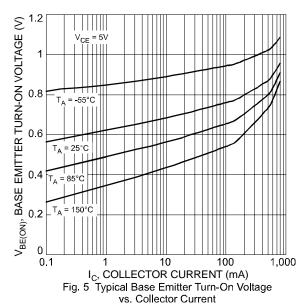


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I<sub>C</sub>, COLLECTOR CURRENT (mA)
Fig. 3 Typical DC Current Gain vs. Collector Current



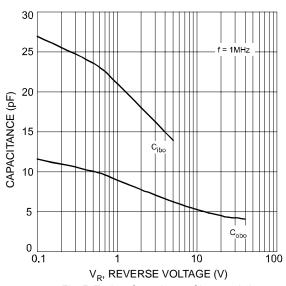


Fig. 7 Typical Capacitance Characteristics

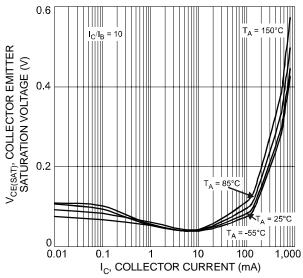


Fig. 4 Typical Collector Emitter Saturation Voltage vs. Collector Current

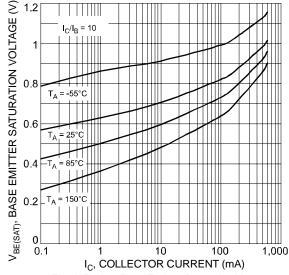
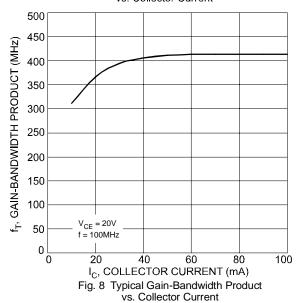


Fig. 6 Typical Base Emitter Saturation Voltage vs. Collector Current



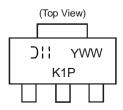


### Ordering Information (Note 5)

Device	Packaging	Shipping
DZT2222A-13	SOT-223	2500/Tape & Reel

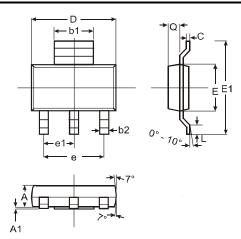
Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

## **Marking Information**



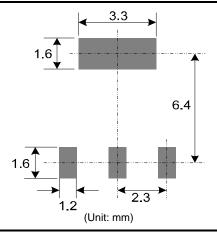
K1P = Product Type Marking Code YWW = Date Code Marking Y = Last Digit of Year ex: 7 = 2007 WW = Week Code 01-52

# **Package Outline Dimensions**



SOT-223					
Dim	Min	Max	Тур		
Α	1.55	1.65	1.60		
A1	0.010	0.15	0.05		
b1	2.90	3.10	3.00		
b2	0.60	0.80	0.70		
C	0.20	0.30	0.25		
D	6.45	6.55	6.50		
Е	3.45	3.55	3.50		
E1	6.90	7.10	7.00		
е	_		4.60		
e1	_	_	2.30		
L	0.55	0.75	0.65		
ø	0.84	0.94	0.89		
All Dimensions in mm					

# Suggested Pad Layout: (Based on IPC-SM-782)



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